

AMENDMENTS TO THE SPECIFICATION:

Please replace the paragraph beginning on page 8, line 5 and ending on page 8, line 17, with the following amended paragraph:

-- The fillers contained in the adhesive system are preferably structure forming fillers, in particular conducting structure forming fillers. The fillers are usually present in total amounts of about 10 % to about 80 % by weight, preferably in total amounts of about 20 % to about 50 % by weight, and much preferably in total amounts of about 30 % to about 40 % by weight, whereby usually at least 3 % by weight, preferably at least 10 % by weight of the fillers are conductive fillers, in particular carbon black (all percentages are referred to the total weight of the adhesive). It is of course also possible that all fillers are conductive fillers, preferably carbon black, present in the amounts mentioned above for the total filler content.